

### 1-1825108-2 Information

www.helsener.com

For Reference Only

**Part Number** 1-1825108-2

Manufacturer TE Connectivity AMP Connectors

Category Connectors, Interconnects Sockets for ICs, Transistors

**Description** CONN IC DIP SOCKET 28POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

### **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









# 1-1825108-2 Specifications

Manufacturer Part Number	1-1825108-2
Manufacturer	TE Connectivity AMP Connectors
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	Diplomate DL
Type	DIP, 0.6" (15.24mm) Row Spacing
Number of Positions or Pins (Grid)	28 (2 x 14)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	30μin (0.76μm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Closed Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Gold
Contact Finish Thickness - Post	30μin (0.76μm)
Contact Material - Post	Beryllium Copper
Housing Material	Thermoplastic, Glass Filled
Operating Temperature	-55°C ~ 125°C
	Report errors?

#### 1-1825108-2 Guarantees



#### **Quality Guarantees**

We provide 90 days warranty. \*

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

# 1-1825108-2 Payment Methods



















## 1-1825108-2 Shipping Methods













If you have any question about 1-1825108-2, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com